Draft Specification For UV-C Series

BRT-B35CD7B1CSD

Features

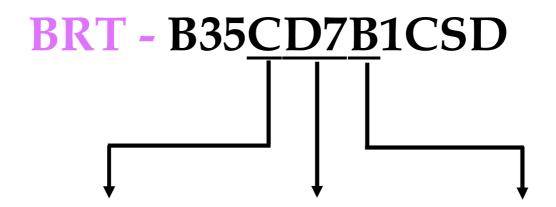
- Deep Ultraviolet LED
- Dimension : 3.45mm(L)×3.45mm(W)
- All Metal Design Cu Substrate
- View Angle 100°
- Low thermal resistance

Applications

- Disinfection
- Chemical and Biological analysis



General Information



Lens

100°Beam Angle

Wavelength-

Deep UV 265~278nm Current-

100mA

BIORAYTRON



Do not poke the Led Lens with sharp object



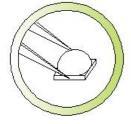
Do not stack assembled PCB



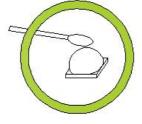
Do not hold the Led with hand



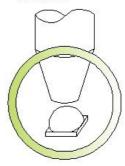
Do not press or push the Led Lens



Hold the Led only by the substrate



Clean the LED surface with cotton bud



Use pick and place nozzle per recommendation in data sheet

Absolute Maximum Ratings

(Tj=25°€)

Parameter	Symbol	Value Ur	
Power Dissipation	P	1 W	
Forward Current	$\mathbf{I_F}$	100	mA
Thermal Resistance, Junction-Case	R _{th} , J-C1	15 °C/W	
Operating Temperature Range	T_{opr}	- 40°C to + 60°C	
Storage Temperature Range	T_{stg}	- 40°C to + 100°C	
Soldering Condition	T_{sol}	260°C For 5 Seconds	

Note: 1. The thermal resistance value is measured with MCPCB (Star).

Initial Electrical/Optical Characteristics

(Tj=25°℃)

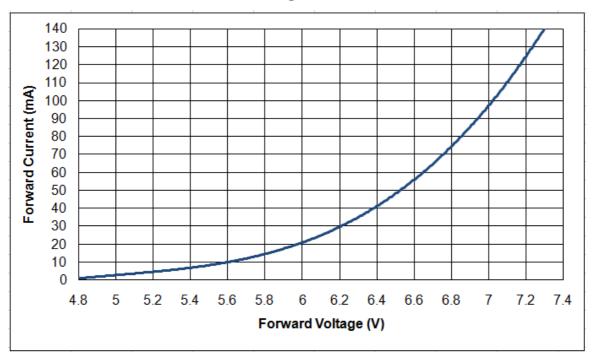
Parameter	Symbol	Min	Тур	Max	Test Condition	Unit
Peak wavelength	λ_p	265	-	278		nm
Radiant Flux	$\Phi_{ m e}$	5	9	-		mW
Radiant Irradiance	E _e	-	3	-	$I_F = 100 \text{mA}$	mW/cm^2
Forward Voltage	\mathbf{V}_{F}	-	7	10		V
Spectra half-width	Δλ	-	15	-		nm

Note

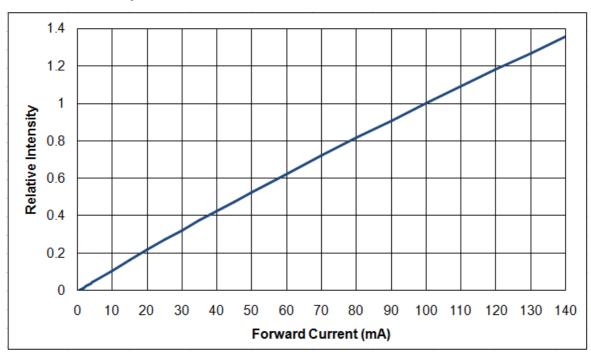
- 1. Forward voltage measurement allowance is \pm 0.2V.
- 2. Radiant flux measurement allowance is \pm 10%.
- 3. Irradiance tested at a distance 10mm from lens top.
- 4. Wavelength measurement allowance is ± 3nm.

Characteristic Diagram

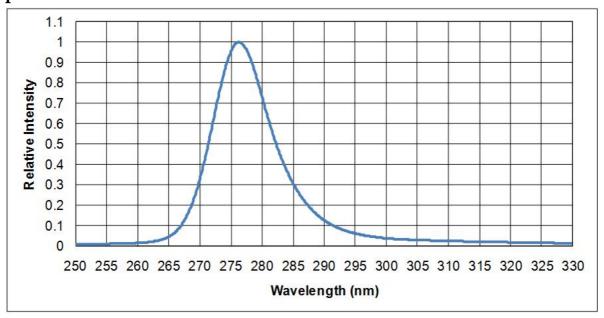
• Forward Current vs. Forward Voltage



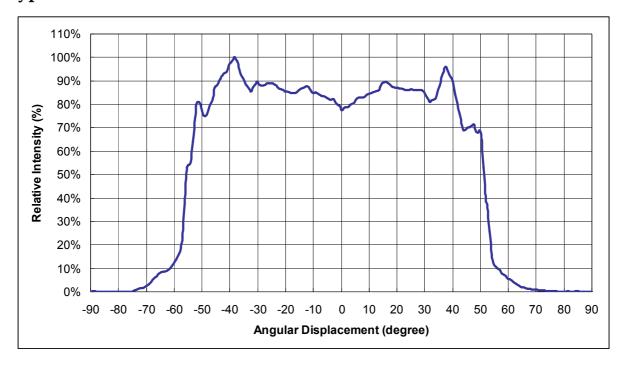
• Relative Intensity vs. Forward Current



Spectral Power Distribution



• Typical Radiation Pattern





• Bin Code List for Reference

(Tj=25 $^{\circ}$ C)

Item	Bin code	Symbol	Condition	Min.	Max.	Unit
Forward Voltage ¹	Е	$ m V_F$	I _F =100 [mA]	5	6	V
	F			6	7	
	G			7	8	
	Н			8	9	
	J			9	10	
Radiant Flux ²	A50	$\Phi_{ m e}$	I _F =100 [mA]	5	8	mW
Nauiaill Flux	A80			8	12	11177

Bin Rank : V_F - Φ_e

Note

- 1. Forward voltage measurement allowance is ± 0.2 V.
- 2. Radiant flux measurement allowance is $\pm 10\%$.

Outline Dimension

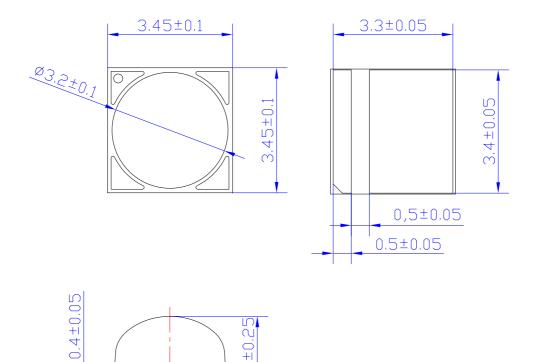
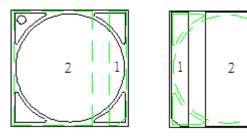


Fig. Package Outline Drawing.

Pad Configuration



PAD	Function				
1	Cathode				
2	Anode · Thermal				

TOP BOTTOM

Fig. Pad configuration.

Note: Please don't put conductive material on the top surface of LEDs.

Recommended Solder Pattern

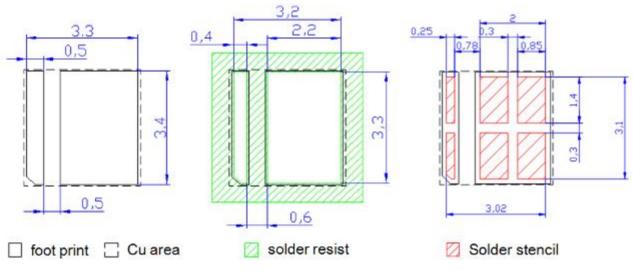


Fig. Solder Pad Layout.

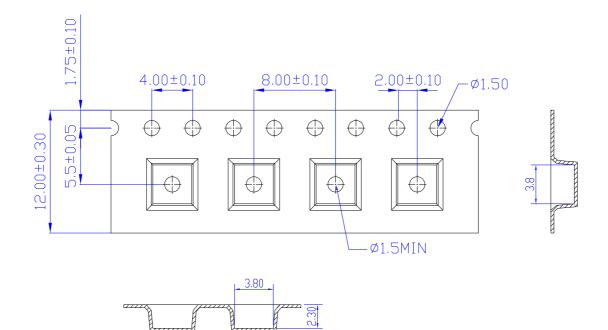


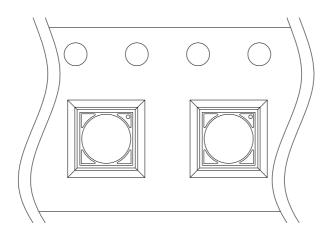
Shipping Package Style

Tapping Dimension Packaging Specification

- Moisture proof bag.
- 1 Reel/bag.
- Q'ty: 700(MAX)/Reel

Unit: mm





Label Formation

P/N: XXXXXXXXXXXXXX BIN Rank : XXXXXXXXXX LOT: XXXXXXXXXXXXXXX Q'ty : XXXX PCS XXX

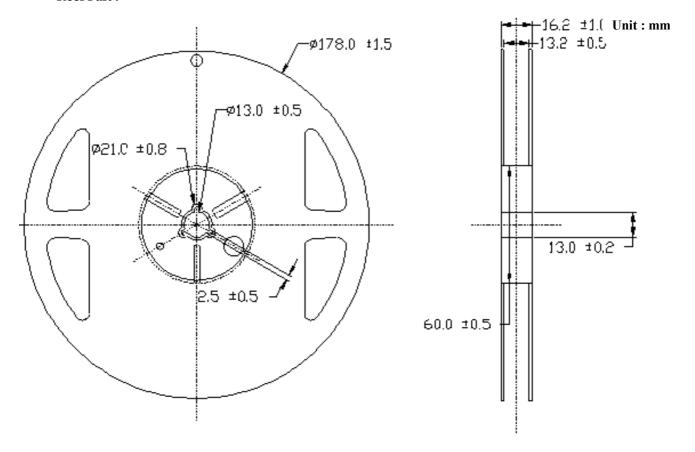
75mm*8mm

Package

Вох Туре	Dimension (mm)	Reel/Box	80°Lens Type(Pcs)
Small Box(S)	230x85x265	5 Reel/Box	3500
Middle Box(M)	470x265x270	30 Reel/Box	21000
Large Box(L)	470x435x270	50 Reel/Box	35000

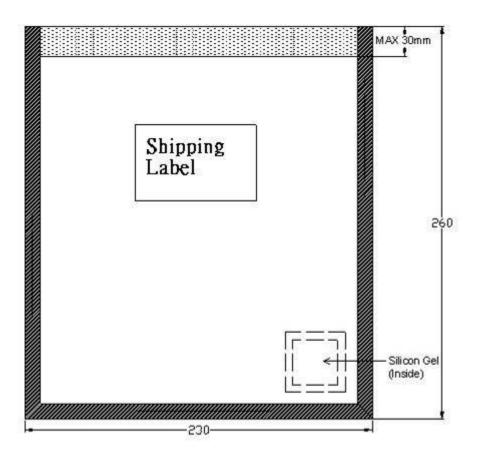
Reel Packaging:

Reel Part:



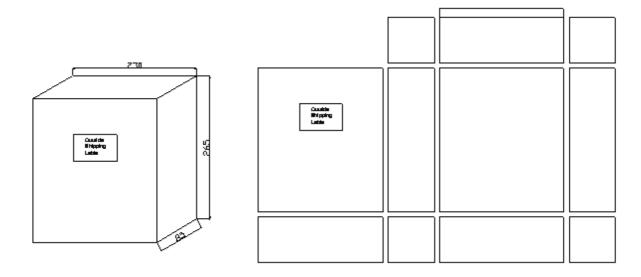
Anti Statistic Bag:

Unit: mm

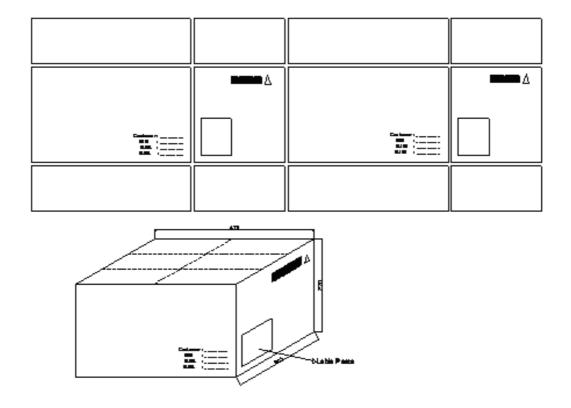


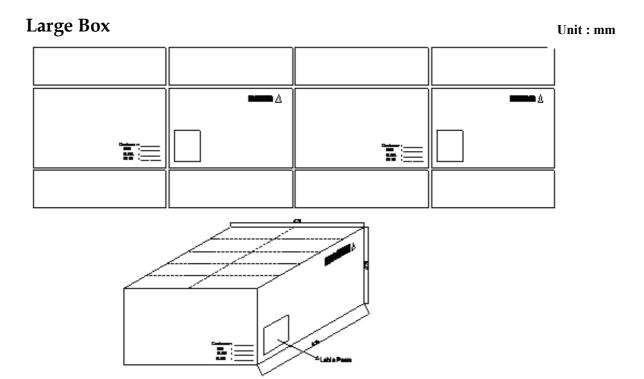
Small Box

Unit: mm



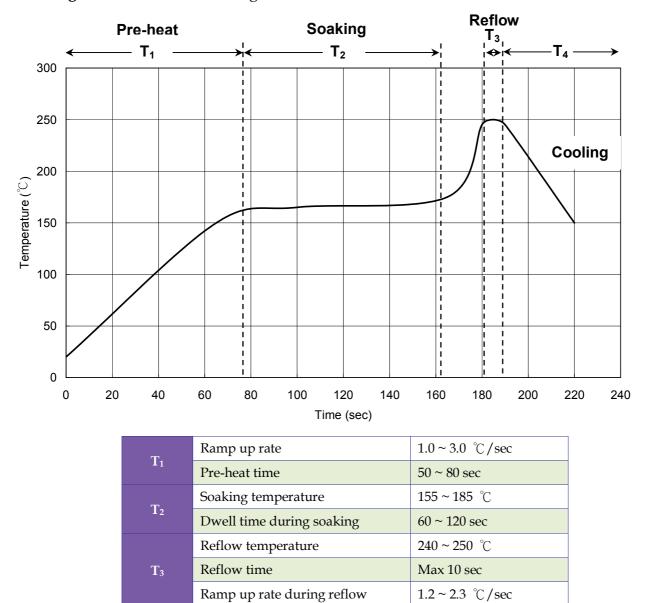
Middle Box Unit: mm





Recommended Solder Profile

Soldering Recommended soldering conditions:



Note: Suggest using Sn96Ag3Cu0.5 lead free solder.

Cooling

 $1.0 \sim 6.0 \, ^{\circ}\text{C/sec}$

Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.



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